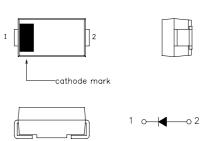


$\label{eq:FRD} FRD \quad \mathrm{Type}: EC11FS4$

FEATURES

- * Miniature Size, Surface Mount Device
- * Ultra-Fast Recovery
- * Low Forward Voltage Drop
- * Low Power Loss, High Efficiency
- * High Surge Capability
- * Packaged in 12mm Tape and Reel
- * Not Rolling During Assembly





Maximum Ratings

Approx Net Weight:0.06g

Rating	Symbol	EC11FS4					
Repetitive Peak Reverse Voltage	VRRM	400					
Non-repetitive Peak Reverse Voltage	Vrsm	440					
Average Rectified Output Current	Io	0.76	Ta=25°C *1		50Hz Half Sine	А	
		1.0	Ta=26°C *2		Wave Resistive Load		
RMS Forward Current	I _{F(RMS)}	1.57					
Surge Forward Current	I _{FSM}	20	50Hz Half Sine	Α			
		20	Non-repetitive				
Operating JunctionTemperature Range	T_{jw}	-40 to +150				°C	
Storage Temperature Range	T _{stg}	-40 to +150				°C	

Electrical • Thermal Characteristics

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Peak Reverse Current	I _{RM}	Tj= 25°C, VRM= VRRM	-	-	20	μA	
Peak Forward Voltage	VFM	Tj= 25°C, I _{FM} = 1.0A		-	-	1.25	V
Reverse Recovery Time	trr	I_{FM} = 1A, -di/dt= 50A/ μ s	s, Ta= 25°C	-	-	30	ns
Thermal Resistance	Rth _(j-a)	Junction to Ambient	*1	-	-	157	°C/W
			*2	-	-	108	C/W

*1 Glass Epoxy Substrate Mounted (Soldering Lands=2x2mm,Both Sides)

*2 Alumina Substrate Mounted (Soldering Lands=2x2mm,Both Sides)



EC11FS4 OUTLINE DRAWING (Dimensions in mm)

